## Nch 100V 30A Power MOSFET

$V_{DSS}$	100V
R <sub>DS(on)</sub> (Max.)	46mΩ
I <sub>D</sub>	±30A
$P_{D}$	50W

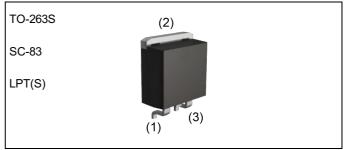
### Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) High power small mold package
- 4) Pb-free lead plating; RoHS compliant

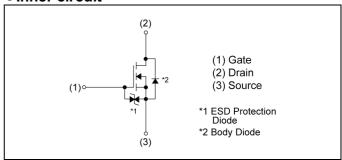
## Application

Switching

## Outline



## •Inner circuit



Packaging specifications

	ing opcomouncing	
	Packing	Embossed Tape
	Reel size (mm)	330
Туре	Tape width (mm)	24
	Quantity (pcs)	1000
	Taping code	TL
	Marking	RSJ301N10

## ● **Absolute maximum ratings** (T<sub>a</sub> = 25°C ,unless otherwise specified)

·		
Symbol	Value	Unit
V <sub>DSS</sub>	100	V
I <sub>D</sub> *1	±30	Α
I <sub>DP</sub> *2	±60	Α
$V_{GSS}$	±20	V
P <sub>D</sub> *1	50	W
T <sub>j</sub>	150	°C
T <sub>stg</sub>	-55 to +150	°C
	$V_{DSS}$ $I_{D}^{*1}$ $I_{DP}^{*2}$ $V_{GSS}$ $P_{D}^{*1}$ $T_{j}$	$V_{DSS}$ 100 $I_{D}^{*1}$ ±30 $I_{DP}^{*2}$ ±60 $V_{GSS}$ ±20 $P_{D}^{*1}$ 50 $T_{j}$ 150

## ●Thermal resistance

Parameter	Cumbal	Values			l lait
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R <sub>thJC</sub> *1	-	1	2.5	°C/W

## ● Electrical characteristics (T<sub>a</sub> = 25°C)

Daramatar	Cymah ol	Conditions			Values		
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	V <sub>(BR)DSS</sub>	$V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$		-	-	V	
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_i} I_D = 1 \text{mA}$ referenced to 25°C		-	116.9	-	mV/°C	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V	-	-	1	μA	
Gate - Source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V	-	-	±10	μΑ	
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = 10V , I <sub>D</sub> = 1mA	1.0	-	2.5	V	
Gate threshold voltage temperature coefficient	$\frac{\DeltaV_{GS(th)}}{\DeltaT_j}$	I <sub>D</sub> = 1mA referenced to 25°C	-	-3.6	-	mV/°C	
Static drain - source	D *3	V <sub>GS</sub> = 10V, I <sub>D</sub> = 15A	-	33	46	O	
on - state resistance	R <sub>DS(on)</sub> *3	V <sub>GS</sub> = 4.0V, I <sub>D</sub> = 15A	-	- 36		mΩ	
Gate resistance	$R_G$	f = 1MHz, open drain	-	4.8	-	Ω	
Forward Transfer Admittance	Y <sub>fs</sub>  *3	V <sub>DS</sub> = 10V, I <sub>D</sub> = 15A	14	-	-	S	

<sup>\*1</sup>  $T_c$  =25°C, Limited only by maximum temperature allowed.

<sup>\*2</sup> Pw≦10µs, Duty cycle≦1%

<sup>\*3</sup> Pulsed

# ●Electrical characteristics (T<sub>a</sub> = 25°C)

Darameter	Symbol	Conditions	Values			Lloit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	2100	-	_
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 25V	-	180	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	1	120	1	
Turn - on delay time	t <sub>d(on)</sub> *3	$V_{DD} \simeq 50V, V_{GS} = 10V$	1	100	1	
Rise time	t <sub>r</sub> *3	I <sub>D</sub> = 10A	-	35	-	no
Turn - off delay time	$t_{d(off)}^{*3}$ $R_L \approx 5\Omega$ - 150		150	1	ns	
Fall time	t <sub>f</sub> *3	$R_G = 10\Omega$	-	100	-	

# • Gate charge characteristics $(T_a = 25^{\circ}C)$

	\ u	,				
Parameter	Symbol	Conditions		Values		Unit
raianetei	Symbol	Conditions	Min.	Тур.	Max.	Offic
Total gate charge	$Q_g^{*3}$	V <sub>DD</sub> ≃ 50V.	-	60	-	
Gate - Source charge	Q <sub>gs</sub> *3	$V_{DD} \approx 50V$ , $I_D = 30A$ ,	-	6	-	nC
Gate - Drain charge	Q <sub>gd</sub> *3	V <sub>GS</sub> = 10V	-	13	-	

# ●Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

Darameter	Symbol	Conditions	ions		Values	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous forward current	I <sub>S</sub>	T = 25°C	-	-	30	Α
Pulse forward current	I <sub>SP</sub> *2	T <sub>a</sub> = 25°C	-	-	60	Α
Forward voltage	V <sub>SD</sub> *3	V <sub>GS</sub> = 0V, I <sub>S</sub> = 30A	-	-	1.5	V

Fig.1 Power Dissipation Derating Curve

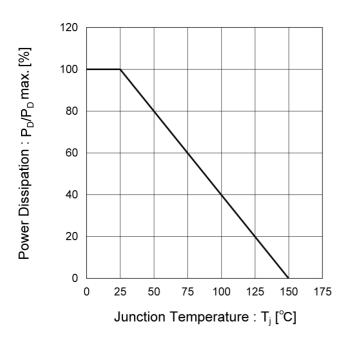
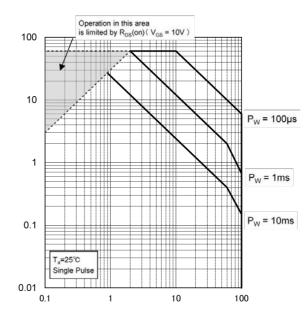


Fig.2 Maximum Safe Operating Area



Drain Current : I<sub>D</sub> [A]

Drain - Source Voltage : V<sub>DS</sub> [V]

Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

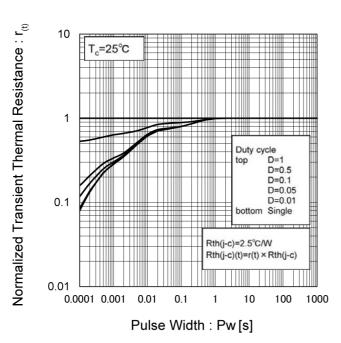


Fig.4 Single Pulse Maximum Power dissipation

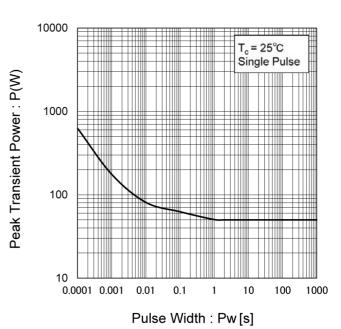


Fig.5 Typical Output Characteristics(I)

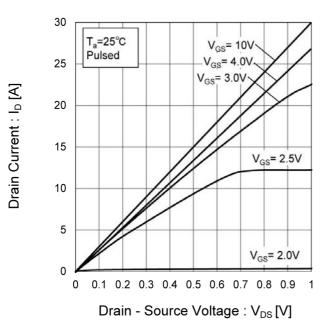
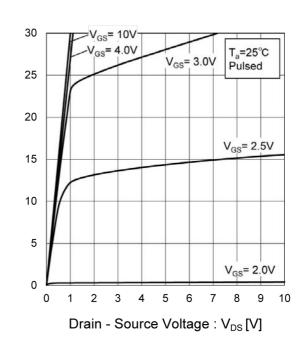


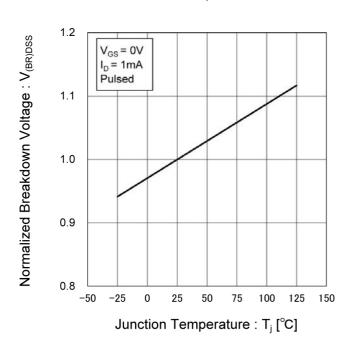
Fig.6 Typical Output Characteristics(II)



Drain Current : I<sub>D</sub> [A]

Fig.7 Breakdown Voltage vs.

Junction Temperature



ROHM

Fig.8 Typical Transfer Characteristics

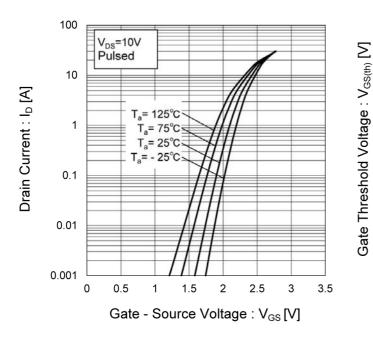


Fig.9 Gate Threshold Voltage vs.
Junction Temperature

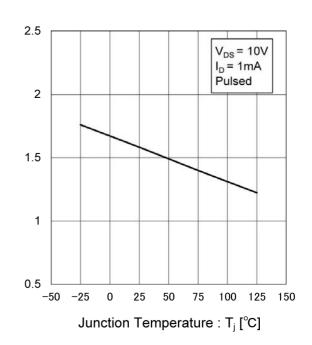


Fig.10 Forward Transfer Admittance vs.
Drain Current

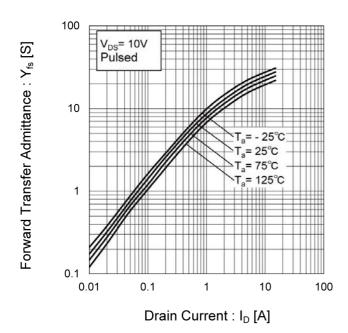


Fig.11 Drain Current Derating Curve

Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

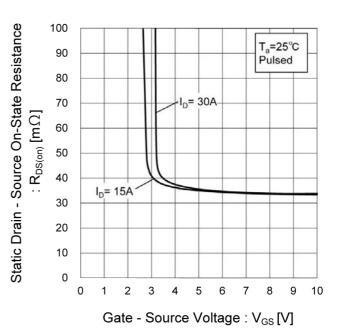
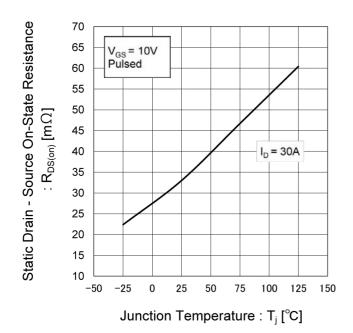


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature



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Fig.14 Static Drain - Source On - State Resistance vs. Drain Current (I)

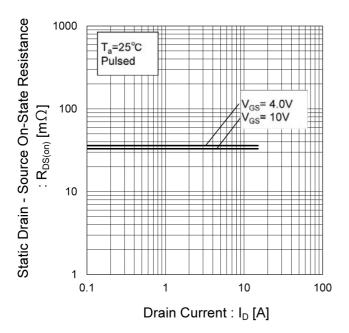


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)

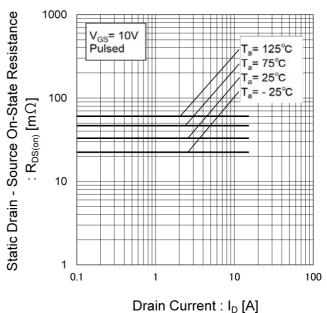


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)

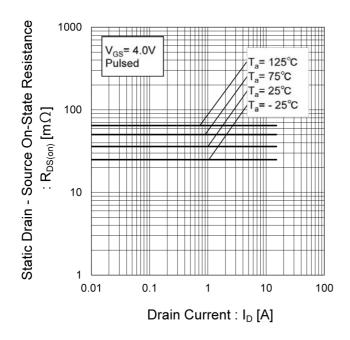


Fig.17 Typical Capacitance vs.

Drain - Source Voltage

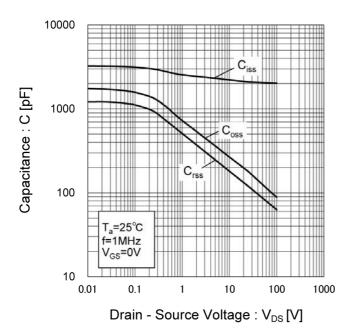


Fig.18 Switching Characteristics

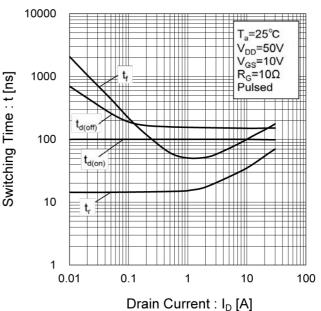


Fig.19 Dynamic Input Characteristics

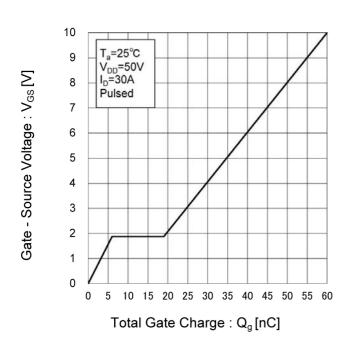
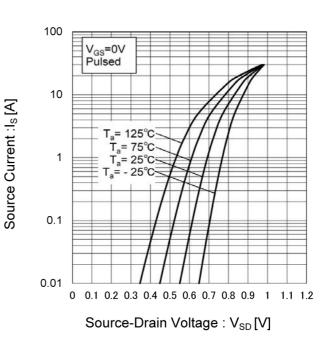


Fig.20 Source Current vs.

Source Drain Voltage



### Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

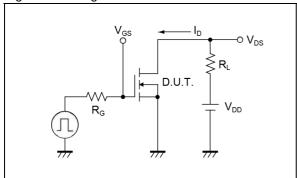


Fig.2-1 Gate Charge Measurement Circuit

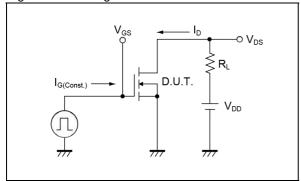


Fig.1-2 Switching Waveforms

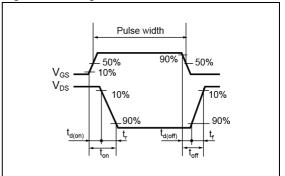
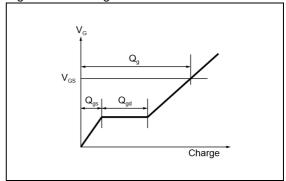
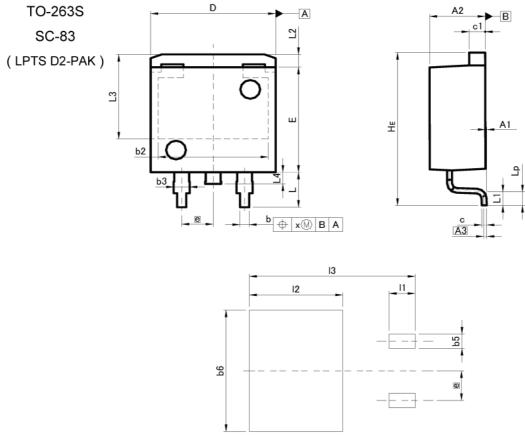


Fig.2-2 Gate Charge Waveform



## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

TRA	MILIM	ETERS	INC	HES	
IM	MIN	MAX	MIN	MAX	
41	0.00	0.30	0.000	0.012	
42	4.30	4.70	0.169	0.185	
43	0.		0.0		
b	0.68	0.98	0.027	0.039	
52		90	0.3		
53	1.14	1.44	0.045	0.057	
С	0.30	0.60	0.012	0.024	
:1	1.10	1.50	0.043	0.059	
D	9.80	10.40	0.386	0.409	
E	8.80	9.20	0.346	0.362	
e		54		100	
HE	12.80	13.40	0.504	0.528	
	2.70	3.30	0.106	0.130	
_1	1.20		0.0	47	
_2	1.10		0.0	143	
_3	7.25		0.285		
_4	1.	00	0.0	39	
_p	0.90	1.50	0.035	0.059	
X	=,	0.25		0.010	
	2-28 7	0.23	TNO		

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
bb	=:	1.23	-	0.049
b6	<b>4</b> 0	10.40	3=4	0.409
11	23	2.10		0.083
12	<del>70</del> 8	7.55	1.75	0.297
13		13.40	-	0.528

Dimension in mm/inches



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1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JÁPAN	USA	EU	CHINA
CLASSⅢ	CL ACCIII	CLASS II b	CL ACCIII
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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